

## Provisional Data

## Distributed Gate Thyristor

### Types R3559TC16x to R3559TC20x

Absolute Maximum Ratings

	VOLTAGE RATINGS (Note 1)	MAXIMUM LIMITS	UNITS
V <sub>DRM</sub>	Repetitive peak off-state voltage	1600-2000	V
V <sub>DSM</sub>	Non-repetitive peak off-state voltage	1600-2000	V
V <sub>R<sub>RRM</sub></sub>	Repetitive peak reverse voltage	1600-2000	V
V <sub>R<sub>S</sub>M</sub>	Non-repetitive peak reverse voltage	1700-2100	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I <sub>T(AV)</sub>	Mean on-state current, T <sub>sink</sub> =55°C (note 2)	3559	A
I <sub>T(AV)</sub>	Mean on-state current, T <sub>sink</sub> =85°C (note 2)	2421	A
I <sub>T(AV)</sub>	Mean on-state current, T <sub>sink</sub> =85°C (note 3)	1447	A
I <sub>T(RMS)</sub>	Nominal RMS on-state current, T <sub>sink</sub> =25°C (note 2)	7060	A
I <sub>T(d.c.)</sub>	D.C. on-state current, T <sub>sink</sub> =25°C (note 4)	6038	A
I <sub>TSM</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> =0.6V <sub>RRM</sub> (note 5)	38.9	kA
I <sub>TSM2</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> ≤10V (note 5)	42.7	kA
I <sup>2</sup> t	I <sup>2</sup> t capacity for fusing t <sub>p</sub> =10ms, V <sub>RM</sub> =0.6V <sub>RRM</sub> (note 5)	7.57×10 <sup>6</sup>	A <sup>2</sup> s
I <sup>2</sup> t	I <sup>2</sup> t capacity for fusing t <sub>p</sub> =10ms, V <sub>RM</sub> ≤10V (note 5)	9.12×10 <sup>6</sup>	A <sup>2</sup> s
di <sub>T</sub> /dt	Maximum rate of rise of on-state current (repetitive) (Note 6)	500	A/μs
	Maximum rate of rise of on-state current (non-repetitive) (Note 6)	1000	A/μs
V <sub>RGM</sub>	Peak reverse gate voltage	5	V
P <sub>G(AV)</sub>	Mean forward gate power	4	W
P <sub>GM</sub>	Peak forward gate power	50	W
V <sub>GD</sub>	Non-trigger gate voltage (Note 7)	0.25	V
T <sub>HS</sub>	Operating temperature range	-40 to +125	°C
T <sub>stg</sub>	Storage temperature range	-40 to +150	°C

## Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for T<sub>j</sub> below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T<sub>j</sub> initial.
- 6) V<sub>D</sub>=67% V<sub>DRM</sub>, I<sub>FG</sub>=2A, t<sub>r</sub>≤0.5μs, T<sub>case</sub>=125°C.
- 7) Rated V<sub>DRM</sub>.

**Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V <sub>TM</sub>	Maximum peak on-state voltage	-	-	1.95	I <sub>TM</sub> =5000A	V
V <sub>0</sub>	Threshold voltage	-	-	1.173		V
r <sub>s</sub>	Slope resistance	-	-	0.155		mΩ
dv/dt	Critical rate of rise of off-state voltage	200	-	-	V <sub>D</sub> =80% V <sub>DRM</sub> , linear ramp	V/μs
I <sub>DRM</sub>	Peak off-state current	-	60	300	Rated V <sub>DRM</sub>	mA
I <sub>RRM</sub>	Peak reverse current	-	-	300	Rated V <sub>RRM</sub>	mA
V <sub>GT</sub>	Gate trigger voltage	-	-	3.0	T <sub>J</sub> =25°C V <sub>D</sub> =10V, I <sub>T</sub> =3A	V
I <sub>GT</sub>	Gate trigger current	-	-	600		mA
I <sub>H</sub>	Holding current	-	-	1000	T <sub>J</sub> =25°C	mA
t <sub>gd</sub>	Gate-controlled turn-on delay time	-	0.8	1.5	V <sub>D</sub> =67% V <sub>DRM</sub> , I <sub>T</sub> =2000A, di/dt=60A/μs,	μs
t <sub>gt</sub>	Turn-on time	-	1.0	2.0	I <sub>FG</sub> =2A, t <sub>r</sub> =0.5μs, T <sub>J</sub> =25°C	
Q <sub>rr</sub>	Recovered charge	-	1750	-	I <sub>TM</sub> =4000A, t <sub>p</sub> =2000μs, di/dt=60A/μs, V <sub>r</sub> =100V	μC
Q <sub>ra</sub>	Recovered charge, 50% Chord	-	750	1500		μC
I <sub>rm</sub>	Reverse recovery current	-	220	-		A
t <sub>rr</sub>	Reverse recovery time, 50% chord	-	7.5	-		μs
t <sub>q</sub>	Turn-off time	-	-	140	I <sub>TM</sub> =4000A, t <sub>p</sub> =2000μs, di/dt=60A/μs, V <sub>r</sub> =100V, V <sub>dr</sub> =67%V <sub>DRM</sub> , dV <sub>dr</sub> /dt=20V/μs	μs
		60	-	200	I <sub>TM</sub> =4000A, t <sub>p</sub> =2000μs, di/dt=60A/μs, V <sub>r</sub> =100V, V <sub>dr</sub> =67%V <sub>DRM</sub> , dV <sub>dr</sub> /dt=200V/μs	
R <sub>th(j-hs)</sub>	Thermal resistance, junction to heatsink	-	-	0.008	Double side cooled	K/W
		-	-	0.016	Single side cooled	K/W
F	Mounting force	63	-	77		kN
W <sub>t</sub>	Weight	-	1.23	-		kg

Notes:-

- 1) Unless otherwise indicated T<sub>J</sub>=125°C.
- 2) The required t<sub>q</sub> (specified with dV<sub>dr</sub>/dt=200V/μs) is represented by an 'x' in the device part number. See ordering information for details of t<sub>q</sub> codes.

**Introduction**

The R3559TC16x-20x Distributed Gate thyristor range features regenerative and interdigitated gating on a fully floating silicon slice (manufacturing reference RTLXCH) mounted in a cold weld capsule. These devices provide fast turn-on and turn-off characteristics and have low turn-on losses. Combined with the large area silicon, they are therefore suitable for induction heating and other high current, medium frequency applications.

**Notes on Ratings and Characteristics****1.0 Voltage Grade Table**

Voltage Grade	V <sub>DRM</sub> V <sub>DSM</sub> V <sub>R<sub>RRM</sub></sub> V	V <sub>RSM</sub> V	V <sub>D</sub> V <sub>R</sub> DC V
16	1600	1700	1040
18	1800	1900	1150
20	2000	2100	1250

**2.0 Extension of Voltage Grades**

This report is applicable to other and higher voltage grades when supply has been agreed by Sales/Production.

**3.0 Extension of Turn-off Time**

This Report is applicable to other  $t_q$ /re-applied  $dv/dt$  combinations when supply has been agreed by Sales/Production.

**4.0 Repetitive  $dv/dt$** 

Higher  $dv/dt$  selections are available up to 1000V/ $\mu$ s on request.

**5.0 De-rating Factor**

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for  $T_j$  below 25°C.

**6.0 Rate of rise of on-state current**

The maximum un-primed rate of rise of on-state current must not exceed 1000A/ $\mu$ s at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 500A/ $\mu$ s at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

**7.0 Square wave ratings**

These ratings are given for load component rate of rise of forward current of 100 and 500 A/ $\mu$ s.

**8.0 Duty cycle lines**

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.

**9.0 Maximum Operating Frequency**

The maximum operating frequency is set by the on-state duty, the time required for the thyristor to turn off ( $t_q$ ) and for the off-state voltage to reach full value ( $t_v$ ), i.e.

$$f_{\max} = \frac{1}{t_{\text{pulse}} + t_q + t_v}$$

10.0 On-State Energy per Pulse Characteristics

These curves enable rapid estimation of device dissipation to be obtained for conditions not covered by the frequency ratings.

Let  $E_p$  be the Energy per pulse for a given current and pulse width, in joules  
 Let  $R_{th(J-Hs)}$  be the steady-state d.c. thermal resistance (junction to sink)  
 and  $T_{SINK}$  be the heat sink temperature.

Then the average dissipation will be:

$$W_{AV} = E_P \cdot f \text{ and } T_{SINK(max.)} = 125 - (W_{AV} \cdot R_{th(J-Hs)})$$

11.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50%  $I_{rm}$  chord as shown in Fig. 1 below.

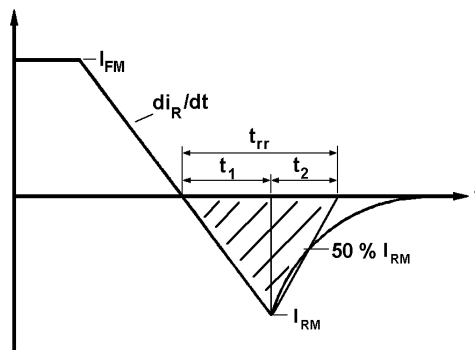


Fig. 1

(ii)  $Q_{rr}$  is based on a 150µs integration time.

i.e. 
$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii) 
$$K \text{ Factor} = \frac{t1}{t2}$$

12.0 Reverse Recovery Loss

12.1 Determination by Measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1, Page 5) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new heat sink temperature can then be evaluated from:

$$T_{SINK(new)} = T_{SINK(original)} - E \cdot (k + f \cdot R_{th(J-Hs)})$$

where  $k = 0.227$  (°C/W)/s

E = Area under reverse loss waveform per pulse in joules (W.s.)

f = rated frequency Hz at the original heat sink temperature.

$R_{th(J-Hs)}$  = d.c. thermal resistance (°C/W).

The total dissipation is now given by:

$$W_{(TOT)} = W_{(original)} + E \cdot f$$

### 12.2 Determination without Measurement

In circumstances where it is not possible to measure voltage and current conditions, or for design purposes, the additional losses E in joules may be estimated as follows.

Let E be the value of energy per reverse cycle in joules (curves in Figure 9).  
Let f be the operating frequency in Hz

$$T_{SINK(new)} = T_{SINK(original)} - (E \cdot R_{th} \cdot f)$$

Where  $T_{SINK(new)}$  is the required maximum heat sink temperature and  
 $T_{SINK(original)}$  is the heat sink temperature given with the frequency ratings.

A suitable R-C snubber network is connected across the thyristor to restrict the transient reverse voltage to a peak value ( $V_{rm}$ ) of 67% of the maximum grade. If a different grade is being used or  $V_{rm}$  is other than 67% of Grade, the reverse loss may be approximated by a pro rata adjustment of the maximum value obtained from the curves.

#### **NOTE 1- Reverse Recovery Loss by Measurement**

This thyristor has a low reverse recovered charge and peak reverse recovery current. When measuring the charge care must be taken to ensure that:

- (a) a.c. coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.
- (b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal
- (c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_S \cdot di/dt}$$

Where:  $V_r$  = Commutating source voltage  
 $C_S$  = Snubber capacitance  
 $R$  = Snubber resistance

### 13.0 Gate Drive

The recommended pulse gate drive is 30V, 15Ω with a short-circuit current rise time of not more than 0.5μs. This gate drive must be applied when using the full di/dt capability of the device.

The duration of pulse may need to be configured with respect to the application but should be no shorter than 20μs, otherwise an increase in pulse current could be needed to supply the resulting increase in charge to trigger.

**14.0 Computer Modelling Parameters**

**14.1 Calculating  $V_T$  using ABCD Coefficients**

The on-state characteristic  $I_T$  vs  $V_T$ , on page 7 is represented in two ways;

- (i) the well established  $V_0$  and  $r_s$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_T$  in terms of  $I_T$  given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given in this report for hot and cold characteristics where possible. The resulting values for  $V_T$  agree with the true device characteristic over a current range, which is limited to that plotted.

25°C Coefficients		125°C Coefficients	
A	1.699211	A	3.102332103
B	0.04818511	B	-0.4078209
C	$2.075468 \times 10^{-4}$	C	$4.569058 \times 10^{-6}$
D	-0.01660626	D	0.03250304

**14.2 D.C. Thermal Impedance Calculation**

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left( 1 - e^{-\frac{t}{\tau_p}} \right)$$

Where  $p = 1$  to  $n$ ,  $n$  is the number of terms in the series.

- $t$  = Duration of heating pulse in seconds.
- $r_t$  = Thermal resistance at time  $t$ .
- $r_p$  = Amplitude of  $p_{th}$  term.
- $\tau_p$  = Time Constant of  $r_{th}$  term.

D.C. Double Side Cooled			
Term	1	2	3
$r_p$	$5.228149 \times 10^{-3}$	$3.076205 \times 10^{-3}$	$1.977511 \times 10^{-3}$
$\tau_p$	0.9862513	0.2593041	0.03447094

D.C. Single Side Cooled				
Term	1	2	3	4
$r_p$	0.01186497	$3.872272 \times 10^{-3}$	$3.457033 \times 10^{-3}$	$1.694157 \times 10^{-3}$
$\tau_p$	7.361938	1.651253	0.2019036	0.02934724

**Curves**

Figure 1 – On-state characteristics of Limit device

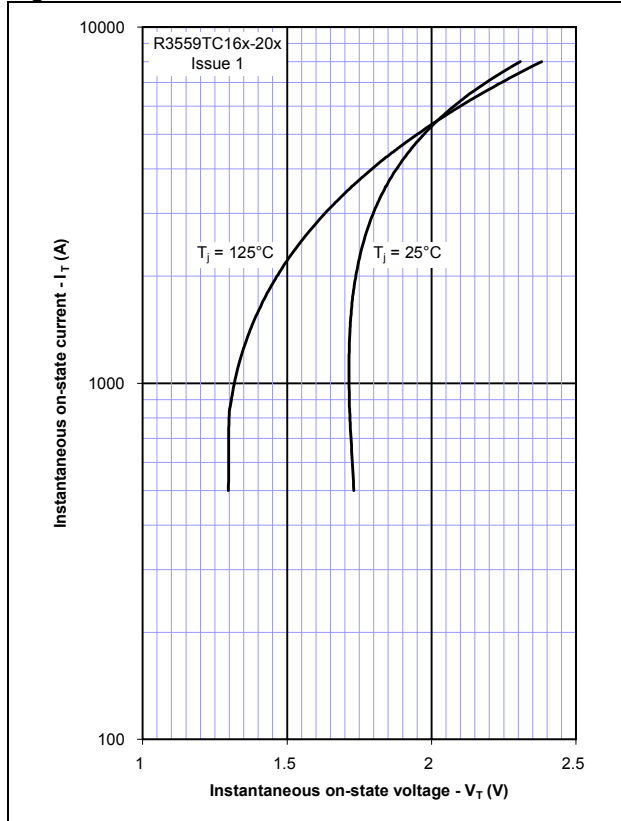


Figure 2 - Transient thermal impedance

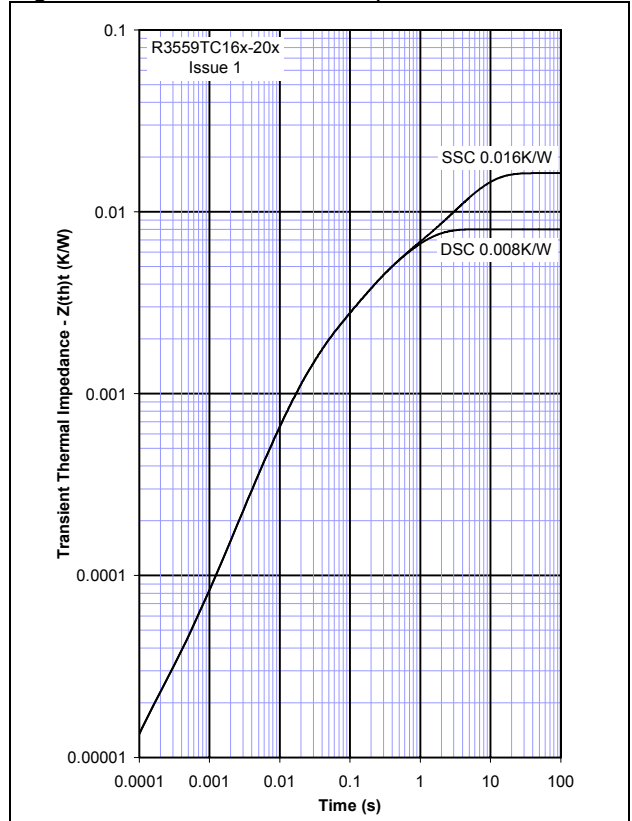


Figure 3 - Gate characteristics - Trigger limits

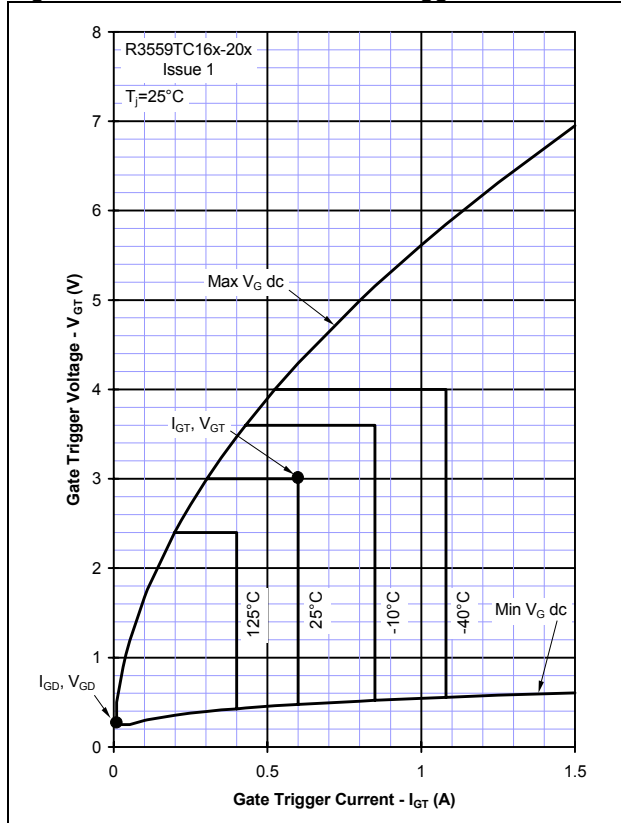


Figure 4 - Gate characteristics - Power curves

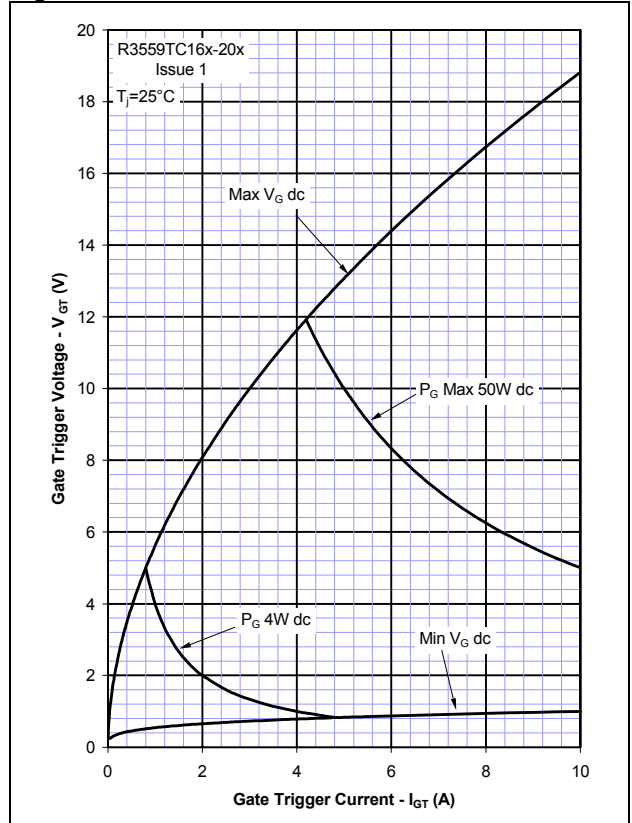


Figure 5 - Total recovered charge,  $Q_{rr}$

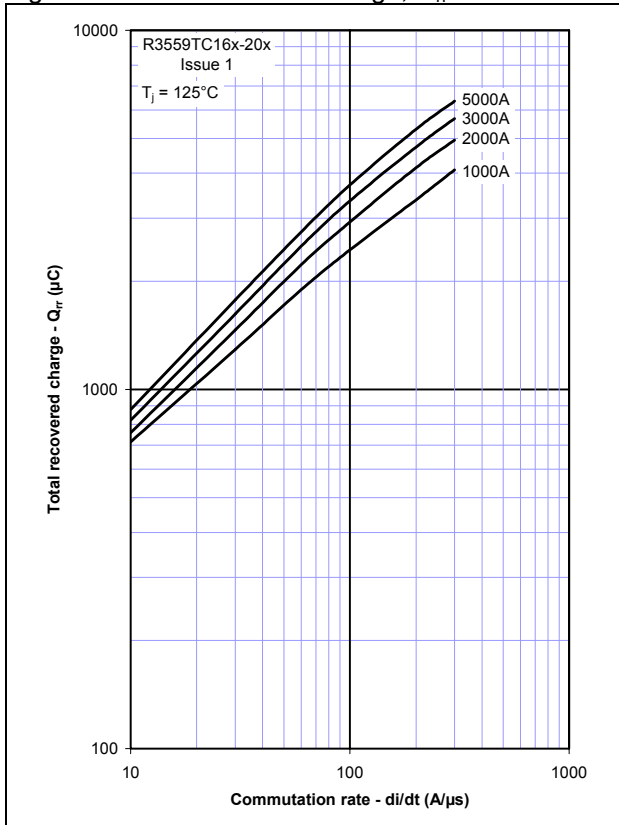


Figure 6 - Recovered charge,  $Q_{ra}$  (50% chord)

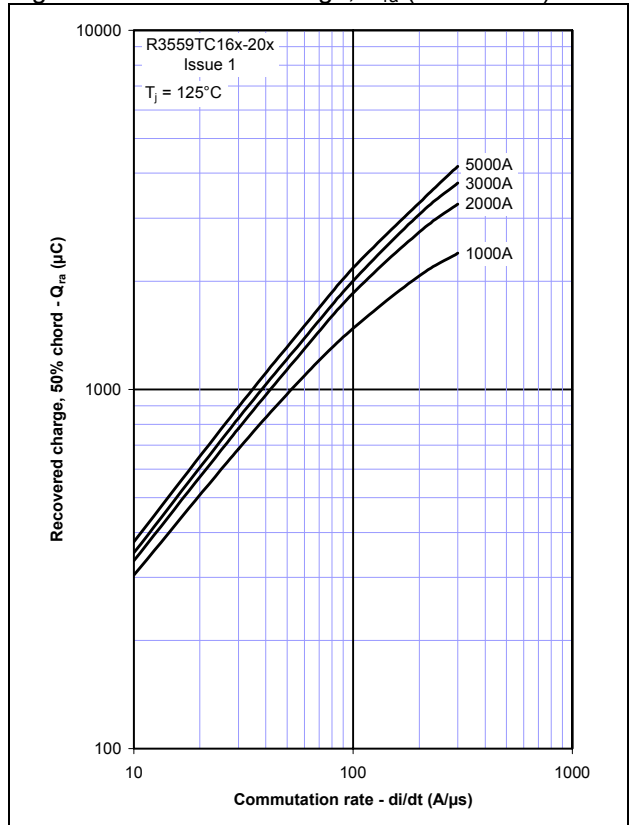


Figure 7 - Peak reverse recovery current,  $I_{rm}$

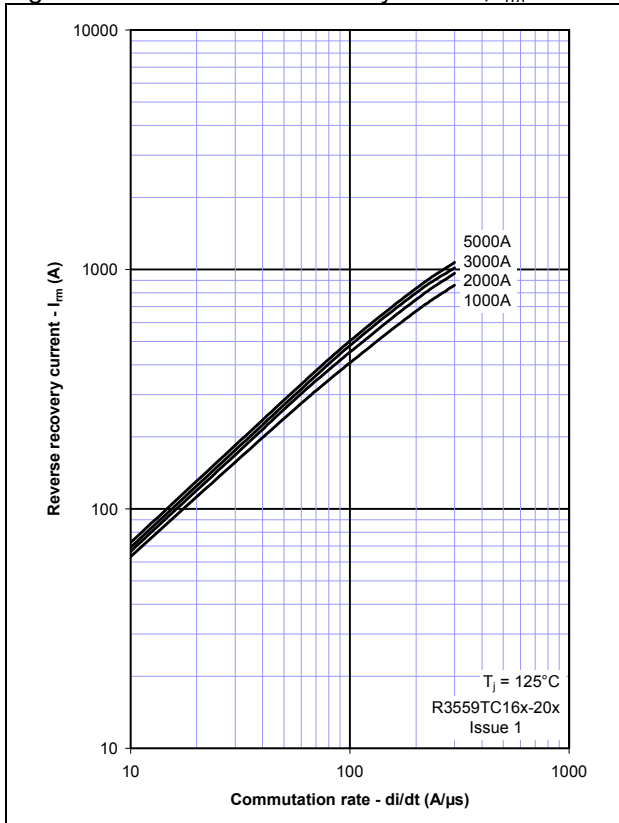


Figure 8 - Maximum recovery time,  $t_{rr}$  (50% chord)

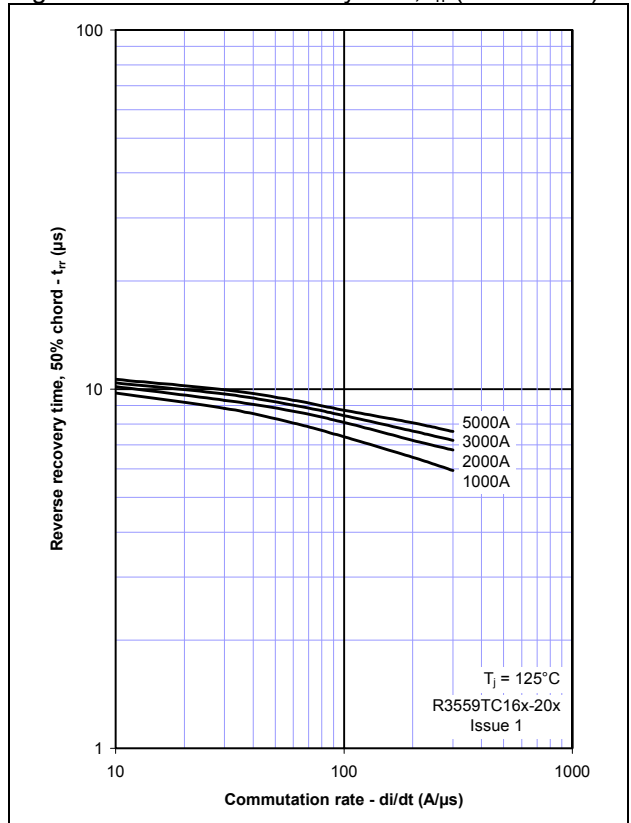




Figure 9 – Reverse Recovery Energy

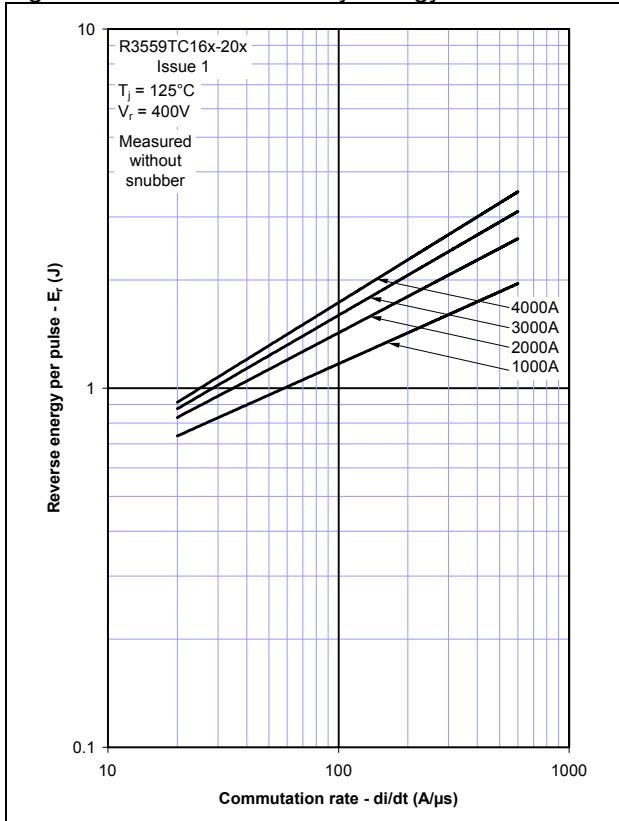


Figure 10 - Sine wave energy per pulse

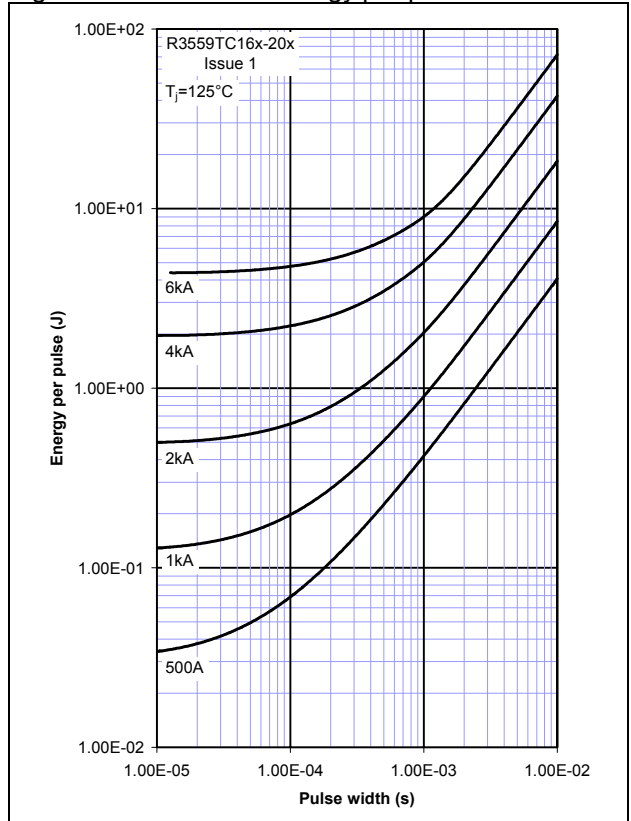


Figure 11 - Sine wave frequency ratings

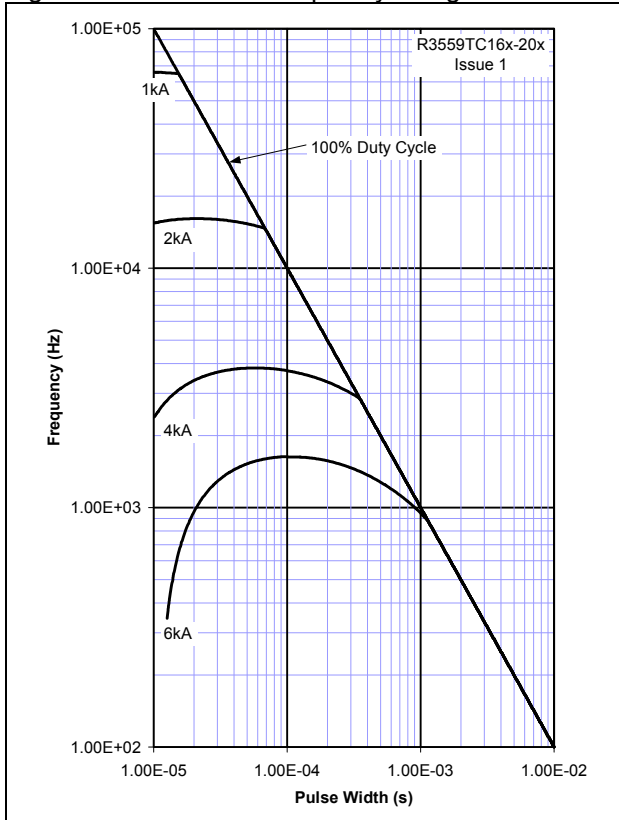


Figure 12 - Sine wave frequency ratings

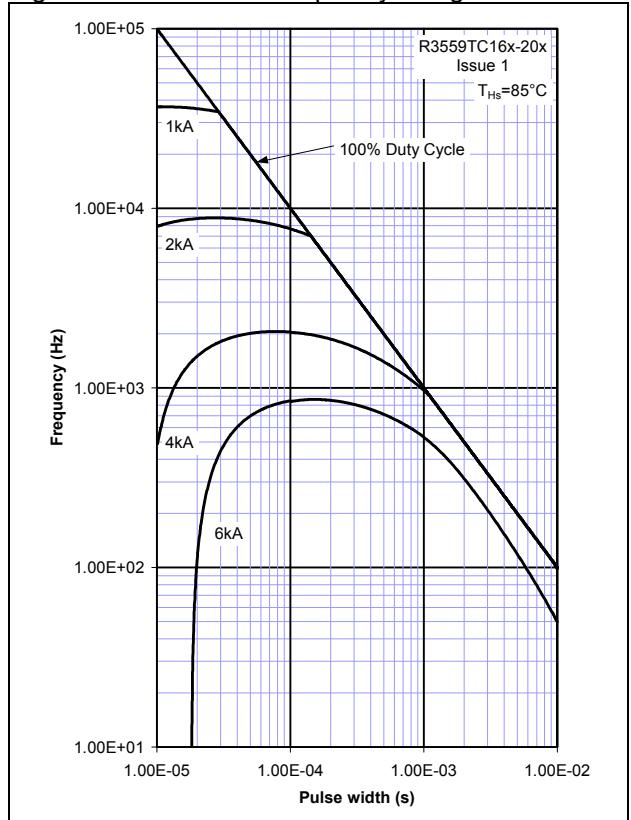


Figure 13 - Square wave frequency ratings

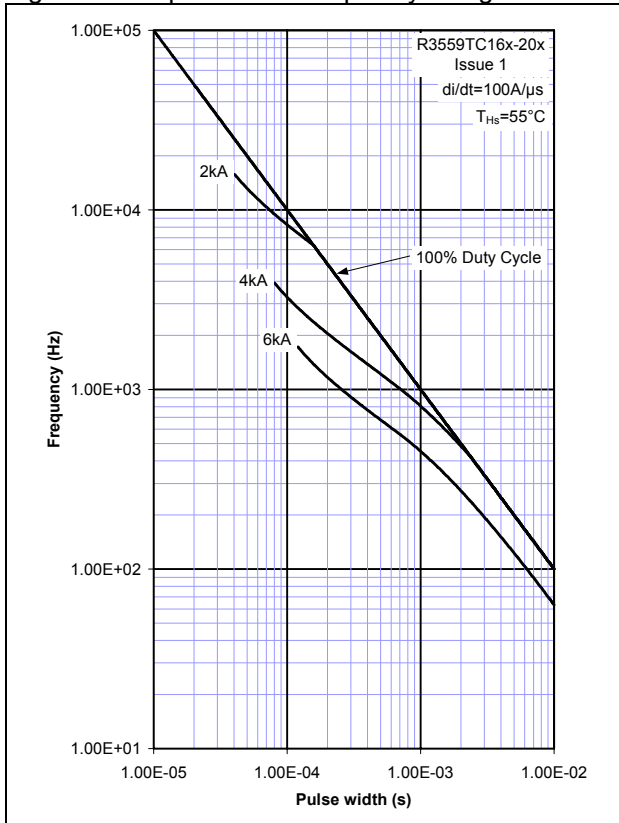


Figure 14 - Square wave frequency ratings

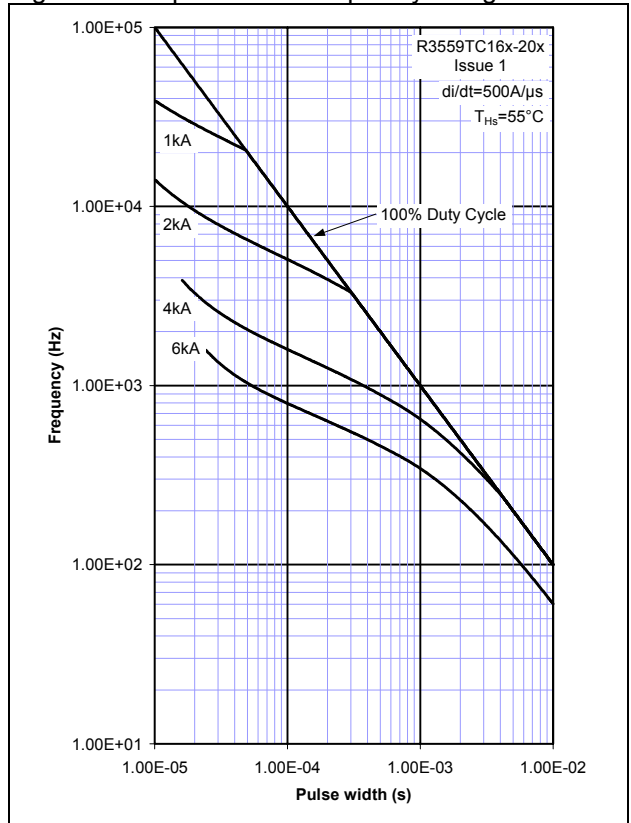


Figure 15 - Square wave frequency ratings

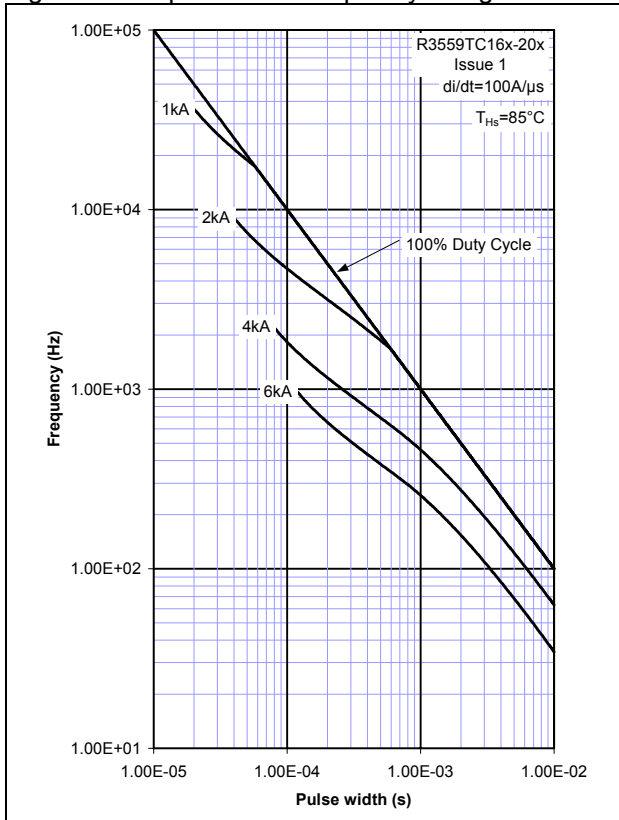


Figure 16 - Square wave frequency ratings

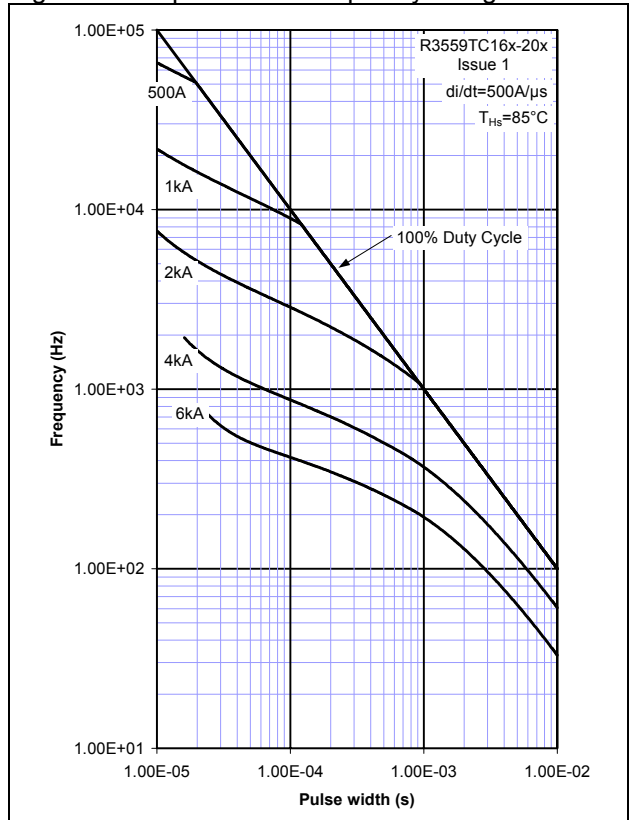


Figure 17 - Square wave energy per pulse

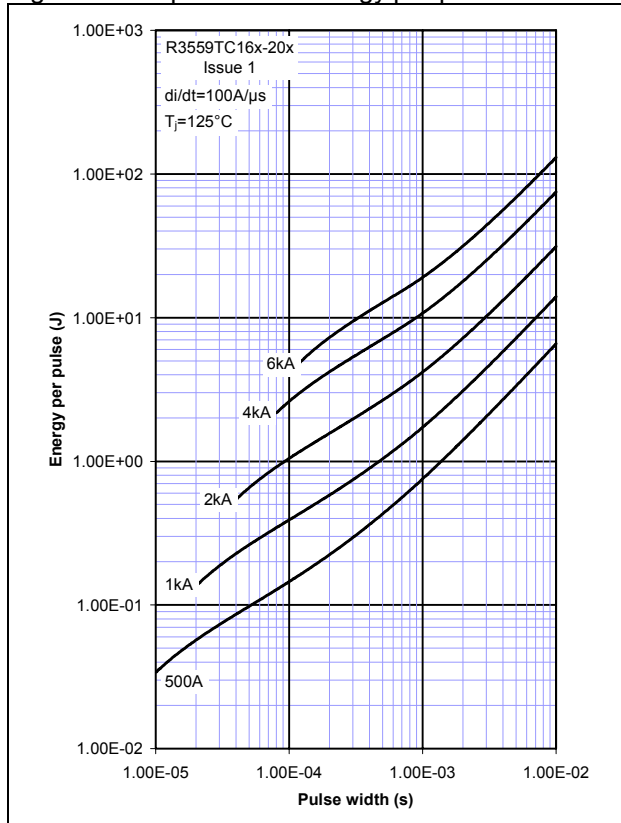


Figure 18 - Square wave energy per pulse

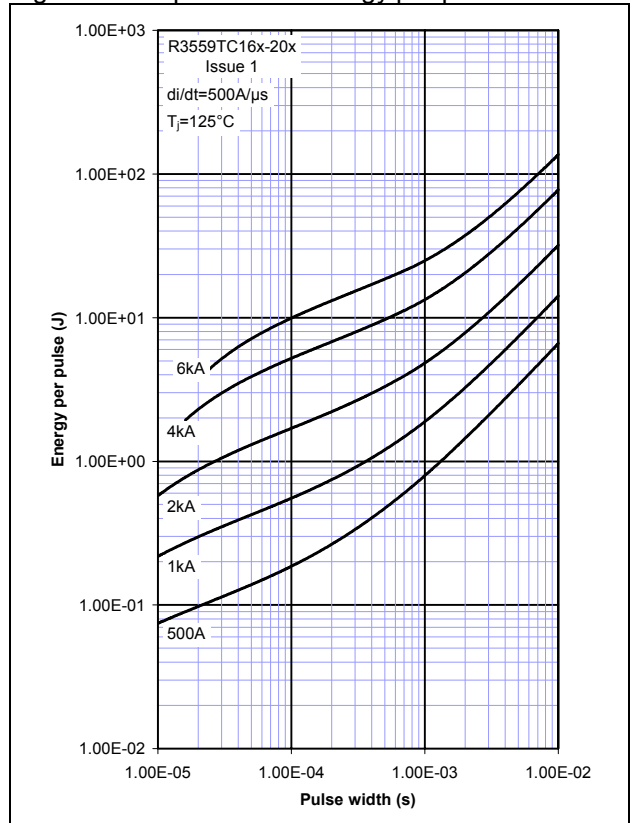
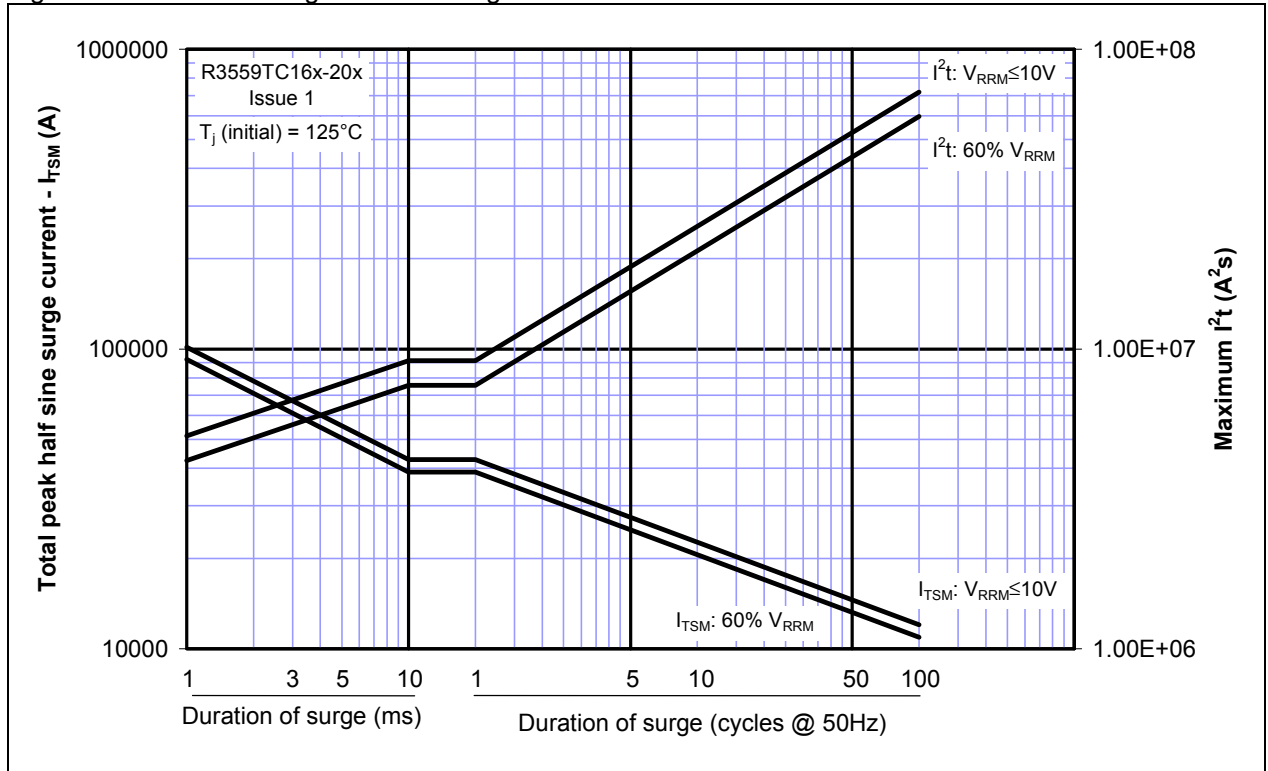
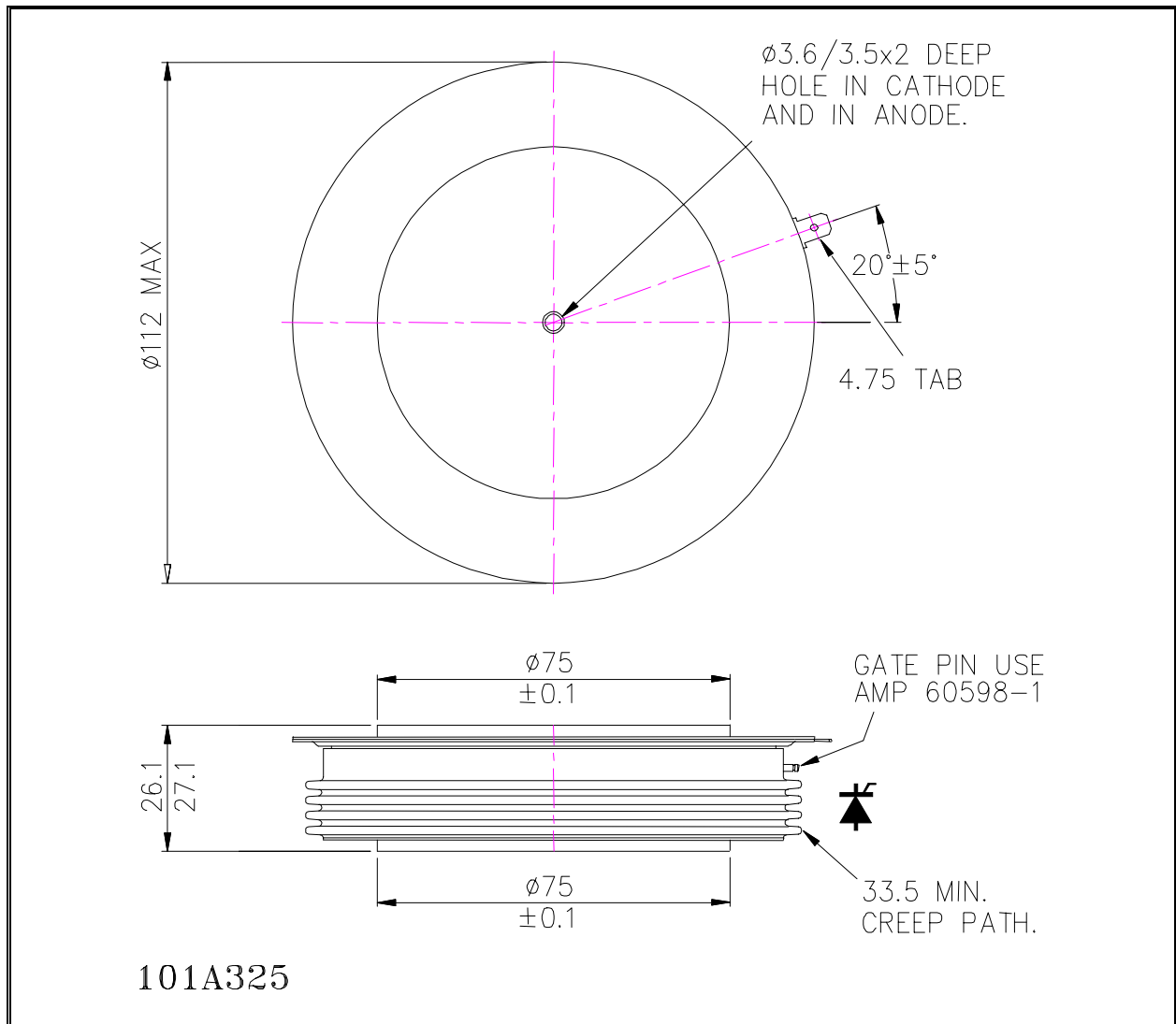


Figure 19 - Maximum surge and I<sup>2</sup>t Ratings



**Outline Drawing & Ordering Information**



**ORDERING INFORMATION** (Please quote 10 digit code as below)

<b>R3559</b> Fixed Type Code	<b>TC</b> Fixed Outline Code	◆ ◆ Off-state Voltage Code $V_{DRM}/100$ 16-20	◆ $t_q$ Code K=60 $\mu$ s, L=65 $\mu$ s, M=70 $\mu$ s, N=100 $\mu$ s
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Typical order code: R3559TC16L – 1600V  $V_{DRM}$ ,  $V_{RRM}$ , 65 $\mu$ s  $t_q$ , 26.1mm clamp height capsule.

**WESTCODE**

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